

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JINGNING SHAN	10/23/2015
WEI ZHANG	11/02/2015
RAINER FASCHING	10/23/2015
TIM HOLME	10/23/2015
RECEIVING PARTY DATA	
Name:	QUANTUMSCAPE CORPORATION
Street Address:	1730 TECHNOLOGY DRIVE
City:	SAN JOSE
State/Country:	CALIFORNIA
Postal Code:	95110
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14288407
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	diana.sciamanna@squirepb.com
Correspondent Name:	SQUIRE PATTON BOGGS (US) LLP
Address Line 1:	600 HANSEN WAY
Address Line 2:	ATTN: TODD OSTOMEL
Address Line 4:	PALO ALTO, CALIFORNIA 94304
ATTORNEY DOCKET NUMBER:	114826.00050
NAME OF SUBMITTER:	TODD OSTOMEL
SIGNATURE:	/Todd OstomelReg63426/
DATE SIGNED:	11/06/2015
Total Attachments: 4	
source=Assignment#page1.tif	
source=Assignment#page2.tif	
source=Assignment#page3.tif	

ASSIGNMENT

WHEREAS, I, **Rainer Fasching**, ASSIGNOR, citizen of Austria, with a mailing address at 729 Bay Road, Mill Valley, California 94941, in relation to the invention for which an application for patent has been filed on May 28, 2014, as U.S. Application No. 14/288,407 (Docket No. 114826.00050), entitled METHOD AND SYSTEM FOR PROCESSING LITHIATED ELECTRODE MATERIAL,

and WHEREAS, **QuantumScape Corporation**, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California 94608, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date

10-23-15

Rainer Fasching

L.S.

Date

10.23.15

Witness (sign and print name)

Witness (sign and print name)

Date

10-23-15

Witness (sign and print name)

ASSIGNMENT

WHEREAS, I, **Tim Holme**, ASSIGNOR, citizen of the United States, with a mailing address at 2447 Thaddeus Drive, Mountain View, California 94043, in relation to the invention for which an application for patent has been filed on May 28, 2014, as U.S. Application No. 14/288,407 (Docket No. 114826.00050), entitled METHOD AND SYSTEM FOR PROCESSING LITHIATED ELECTRODE MATERIAL,

and WHEREAS, **QuantumScape Corporation**, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California 94608, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

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AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date 10-23-15

Tim Holme

L.S.

Tim Holme

Date 10-23-15

[Signature]

Davis D. H. K.

Witness (sign and print name)

Date 10/23/15

[Signature]

Marie A. Mayer

Witness (sign and print name)

ASSIGNMENT

WHEREAS, I, Wei Zhang, ASSIGNOR, citizen of People's Republic of China, with a mailing address at 32389 Lake Temescal Lane, Fremont, California 94555, in relation to the invention for which an application for patent has been filed on May 28, 2014, as U.S. Application No. 14/288,407 (Docket No. 114826.00050), entitled METHOD AND SYSTEM FOR PROCESSING LITHIATED ELECTRODE MATERIAL,

and WHEREAS, QuantumScape Corporation, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California 94608, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND I HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

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AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date 11/02/2015

Wei Zhang L.S.
Wei Zhang

Date 11/2/2015

Mark Leong
Witness (sign and print name)

Date 11/2/2015

Matthew Hu
Witness (sign and print name)

ASSIGNMENT

WHEREAS, I, Jingning Shan, ASSIGNOR, citizen of Canada, with a mailing address at 1034 Bret Knoll, San Jose, California 95120, in relation to the invention for which an application for patent has been filed on May 28, 2014, as U.S. Application No. 14/288,407 (Docket No. 114826.00050), entitled METHOD AND SYSTEM FOR PROCESSING LITHIATED ELECTRODE MATERIAL,

and WHEREAS, QuantumScape Corporation, a corporation organized and existing under the laws of the state of Delaware, and having an office for the transaction of business at 1730 Technology Drive, San Jose, California 94608, herein referred to as "ASSIGNEE", is desirous of obtaining my entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, title and interest in, to and under the said invention, and the said application and all applications claiming priority thereto and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

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AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my respective signature.

Date

Oct. 23 2015

Shan, JN

L.S.

Jingning Shan

Date

Oct 27. 2015

Weijie Wang

Witness (sign and print name)

weijie wang

Date

Oct 27. 2015

Chentao Yu

Witness (sign and print name)

chentao Yu